



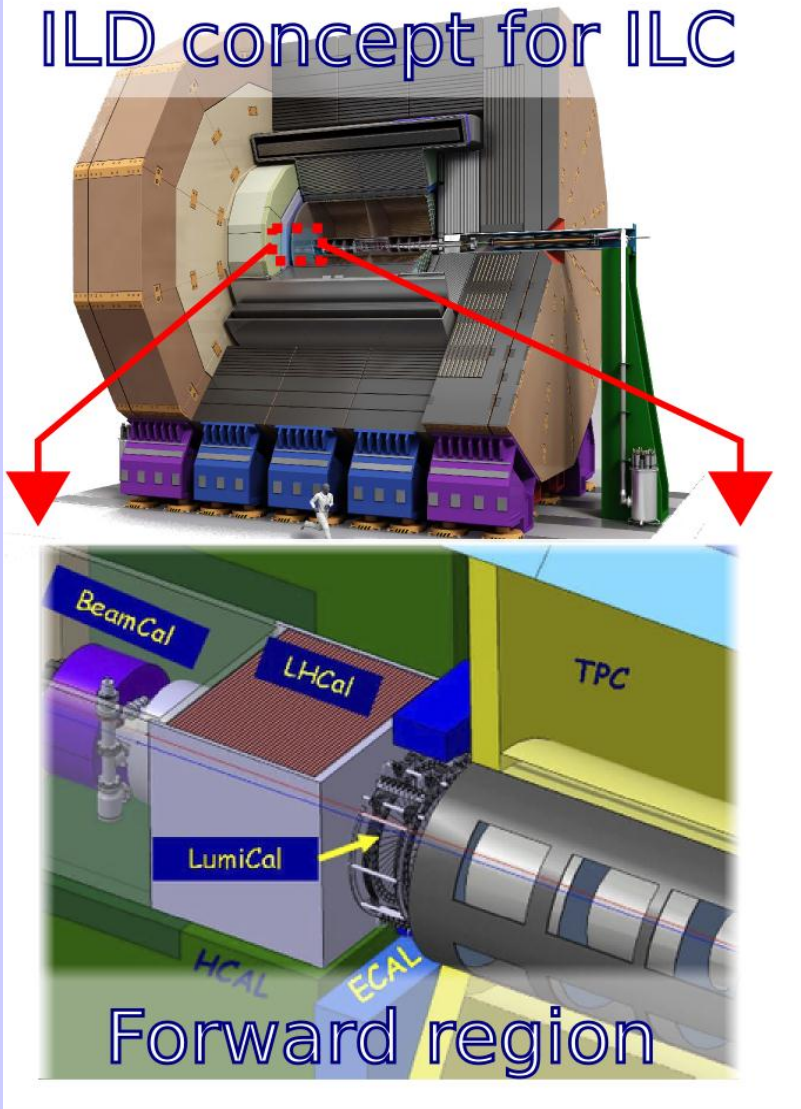
Forward Instrumentation of ILC and CLIC detectors

Wolfgang Lohmann,
BTU and DESY

On behalf of the FCAL collaboration

Labs involved: Argonne, Vinca Inst, Belgrade, Bukharest IFIN-HH & ISS,
CERN, Univ. of Colorado, Cracow AGH-UST & IFJ-PAN,
JINR Dubna, NCPHEP Minsk, Santa Cruz,
Stanford University, SLAC ,
Tuhoku Univ., Tel Aviv Univ., DESY (Z.),
Pontificia Universidad Católica, Chile

ILD concept for ILC



LumiCal:

- precise luminosity measurement, 10^{-3} at ILC , 10^{-2} at 3 TeV

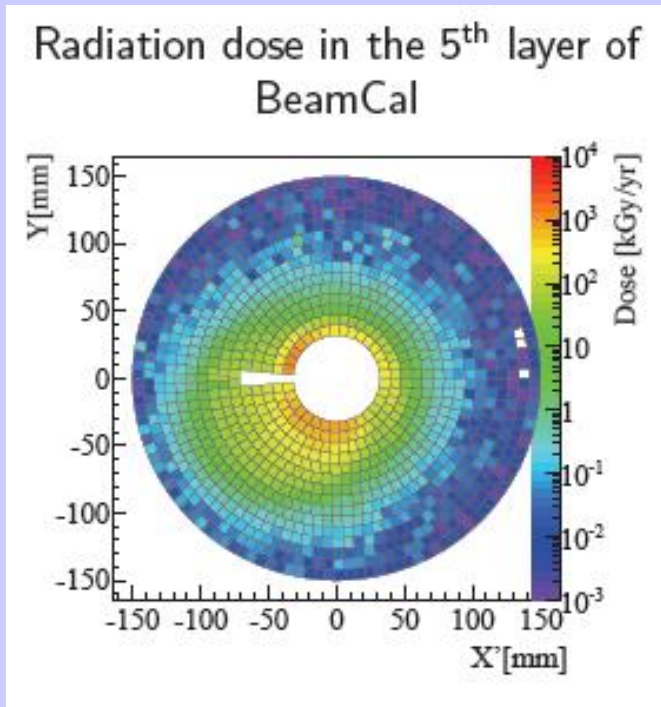
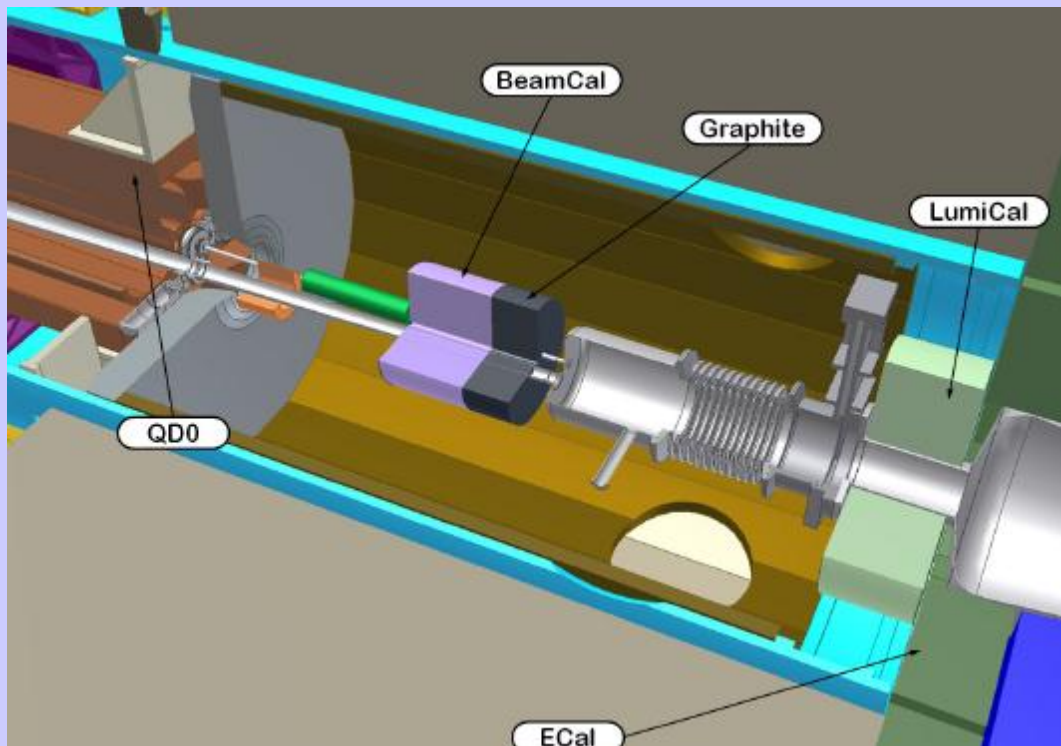
BeamCal (and Pair Monitor):

- hermeticity (electron detection at low polar angles),
- assisting beam tuning (fast feedback from BeamCal and pair monitor data to machine)

Challenges:

- radiation hardness (BeamCal),
- high precision (LumiCal) and
- fast readout (both)

Design of the forward region of a CLIC detector

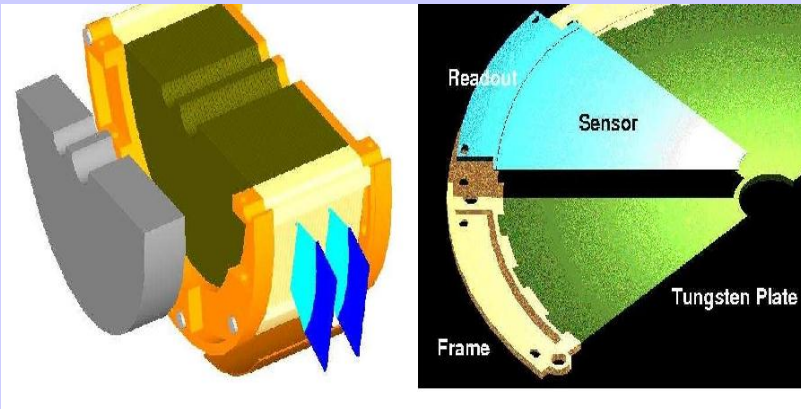


Crossing angle 20 mrad

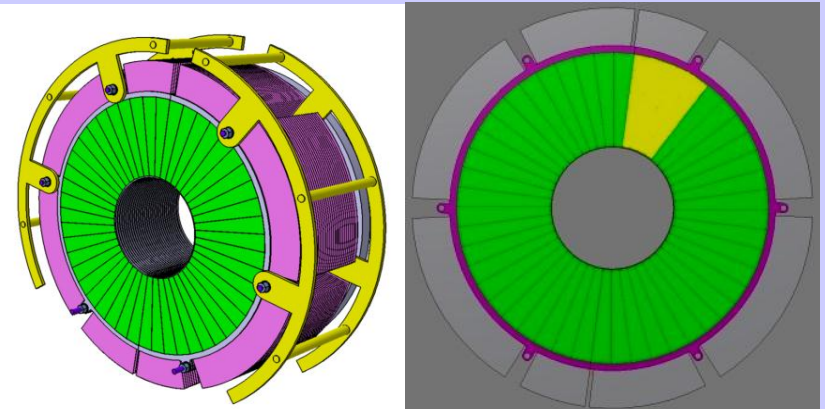
- BeamCal angular coverage 10 – 40 mrad
- LumiCal coverage 38 - 110 mrad
- 40 X_0 depth
- Optimised to minimise backscattered particles

Technology choice: Finely segmented compact calorimeters

BeamCal



LumiCal

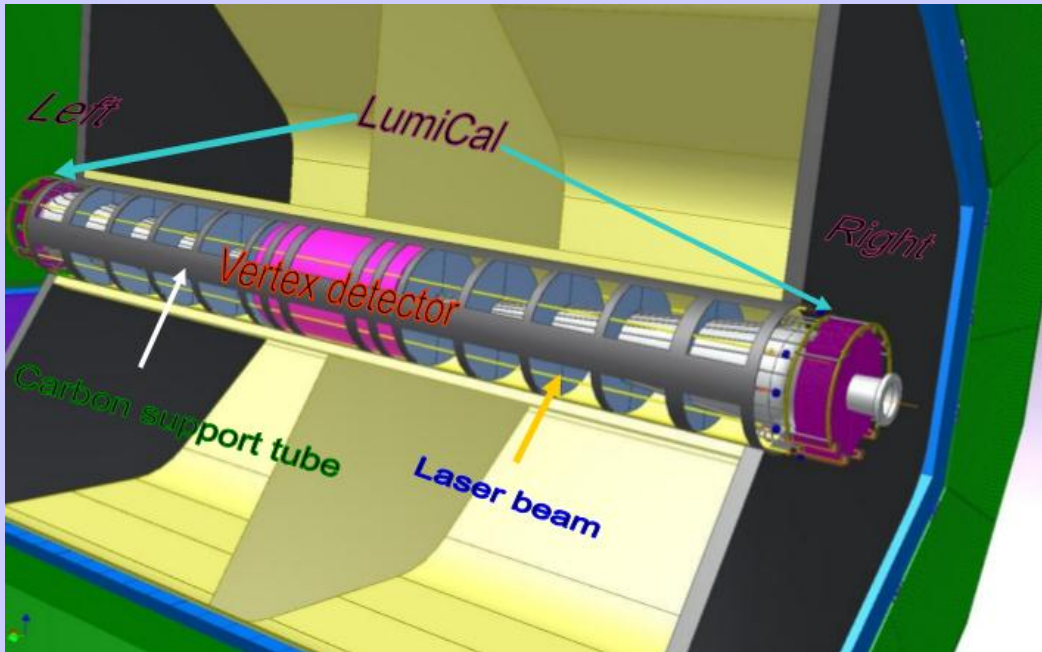
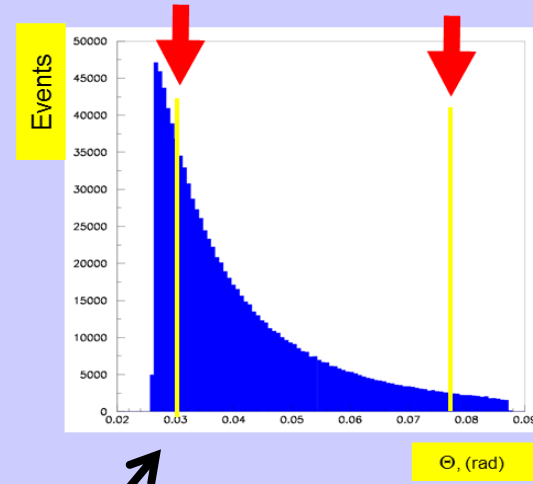
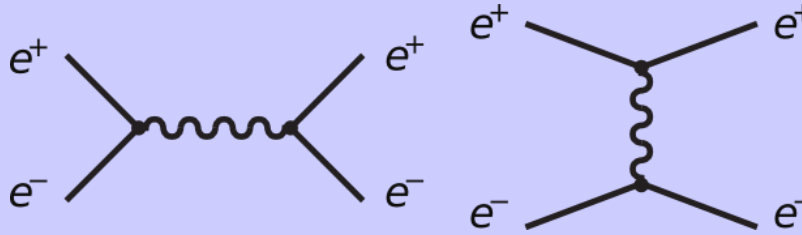


- Tungsten thickness $1 X_0$, 30 layers
- BeamCal sensors GaAs, 500 μm thick
- LumiCal sensors silicon, 320 μm thick
- FE ASICs positioned at the outer radius
- BeamCal angular coverage 5.8 – 43.5 mrad
- LumiCal coverage 31 – 78 mrad

Luminosity:

$$\mathcal{L} = N / \sigma$$

Bhabha scattering:



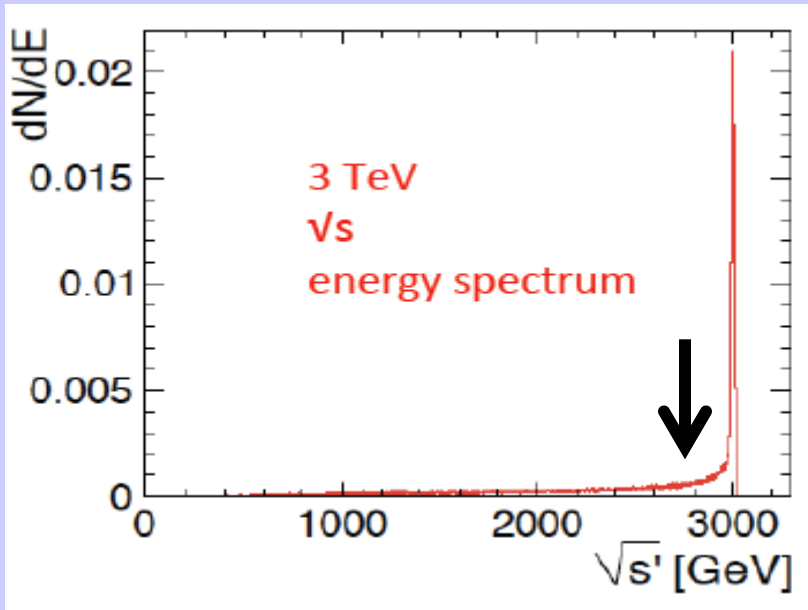
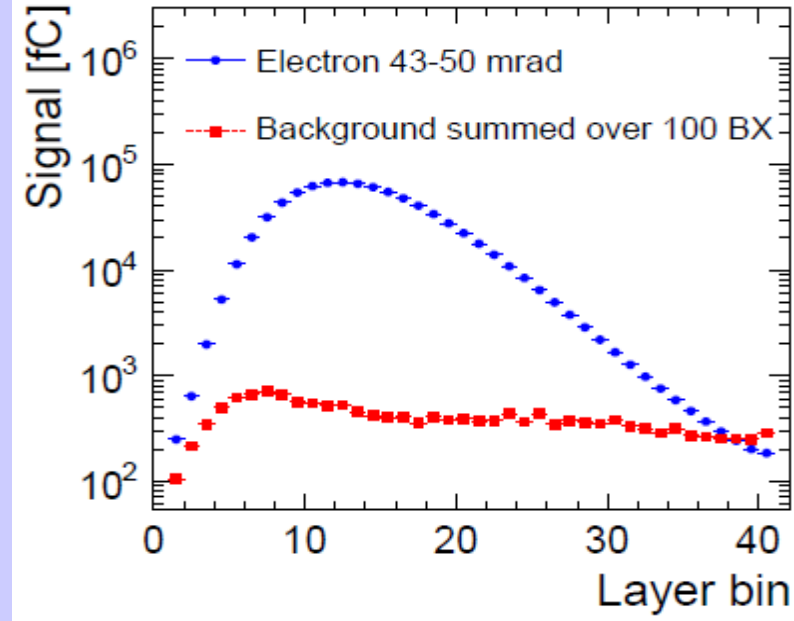
Laser alignment system (LAS) ,
 Integrated in the QD0 alignment

$$\Delta R < 40 \mu\text{m}$$

$$\Delta z < 500 \mu\text{m}$$

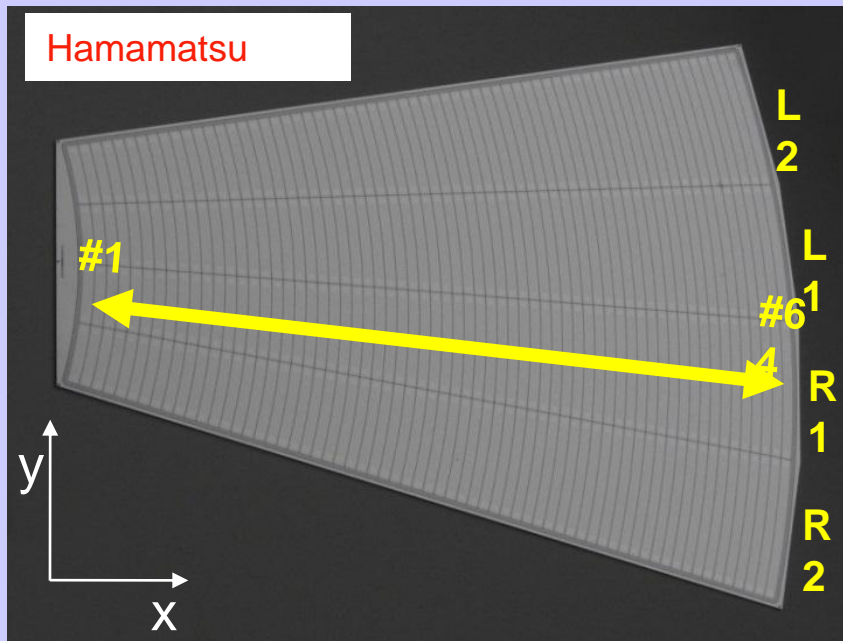
CLIC challenges:

- Beam induced background in LumiCal (occupancy)
- Read-out speed (.5 ns between BX)
- Luminosity spectrum



The precise knowledge of the spectrum shape is essential for the precision of the luminosity measurement !!
 (how to determine -see talk by Andre Sailer)

LumiCal

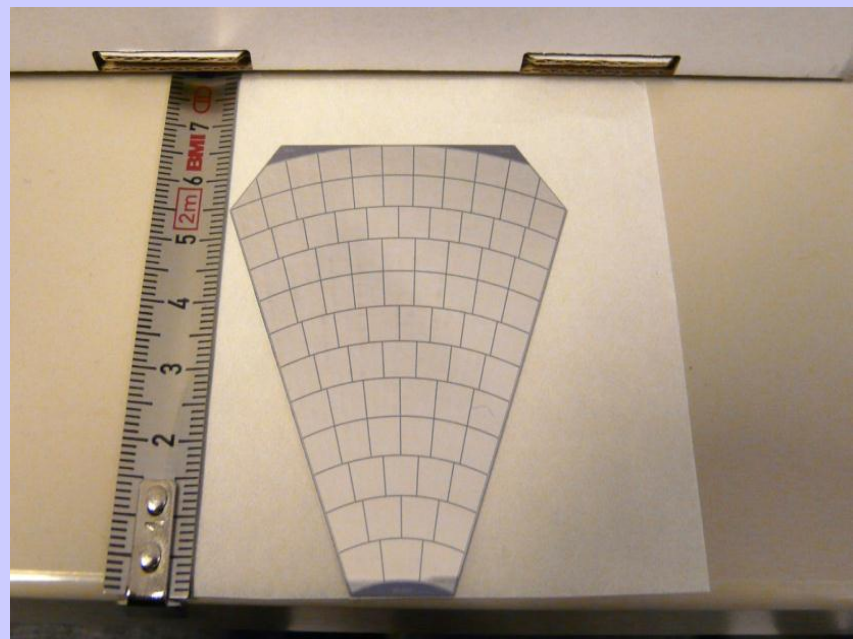


p in n, strip pitch 2.2 mm

40 pieces, joint effort

IFJ PAN Cracow, DESY,
TAU

BeamCal

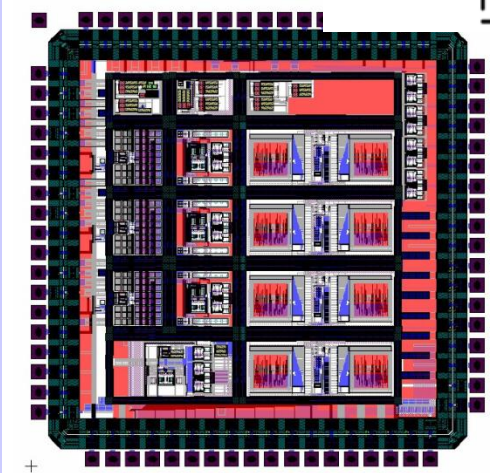
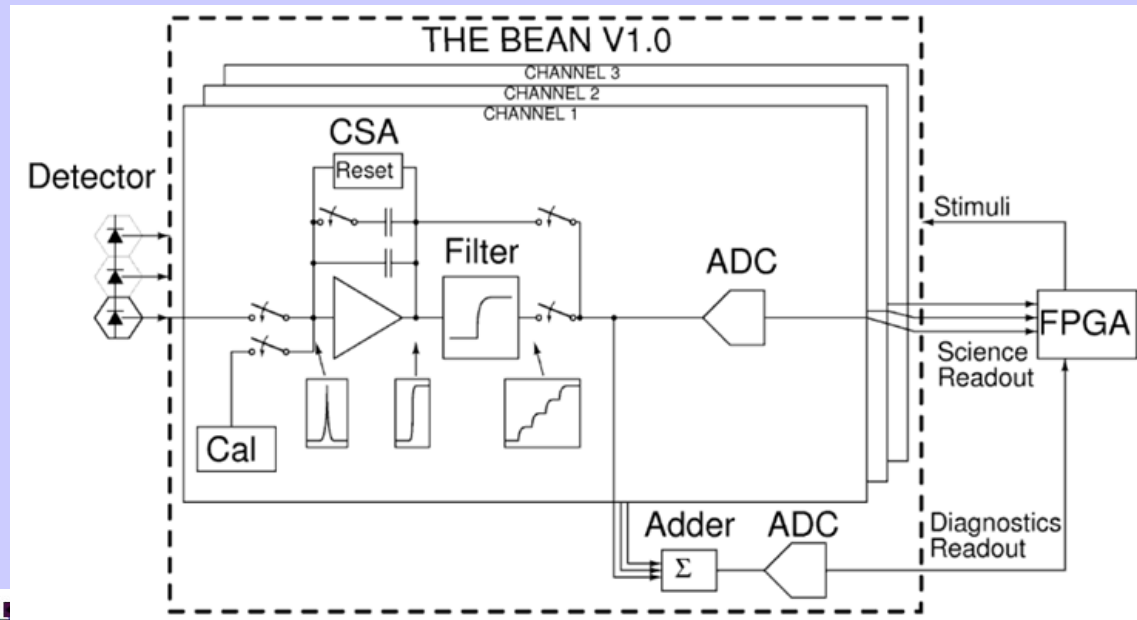


Compensated GaAs

~ 10 pieces,

Institute in Tomsk, DESY-JINR
collaboration (BMBF
supported)

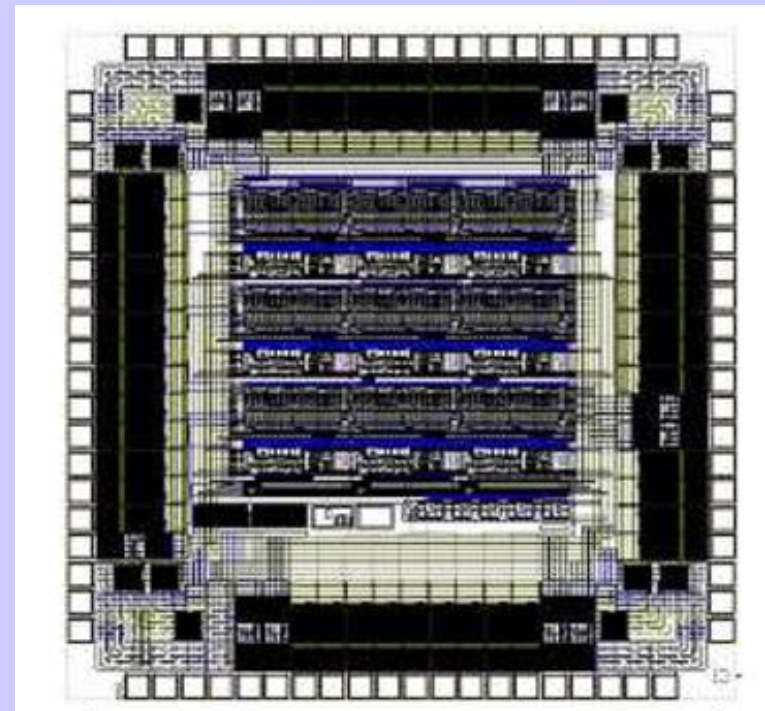
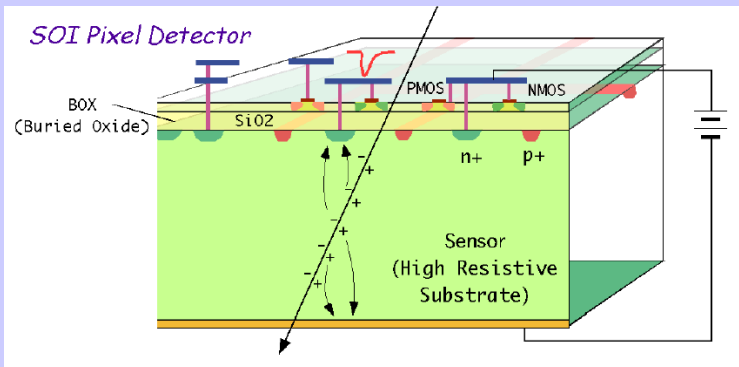
SLAC/ Universidad Católica, Chile (BeamCal)



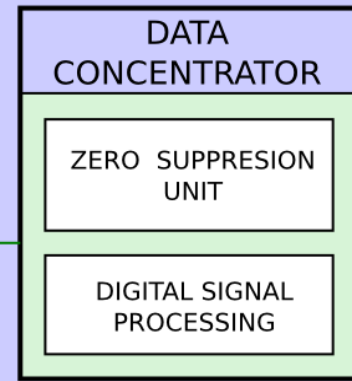
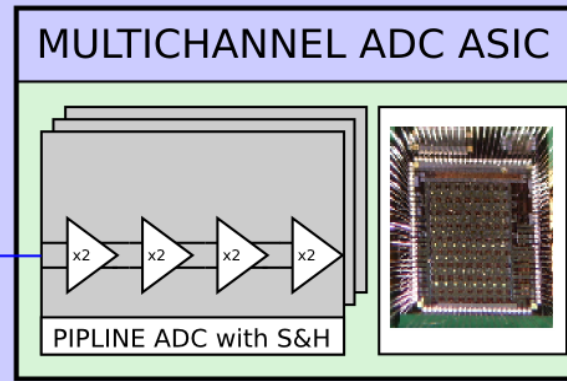
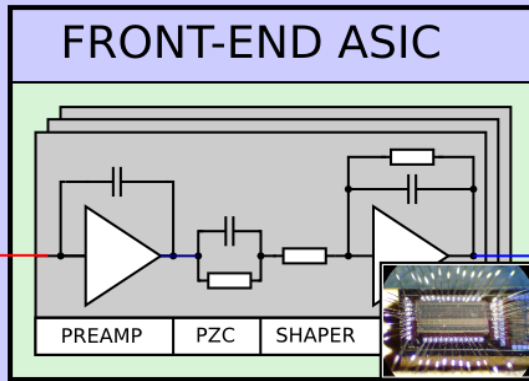
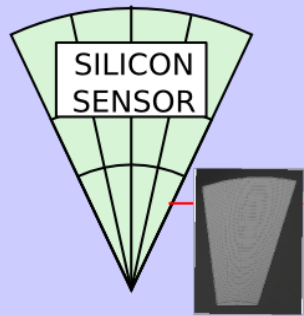
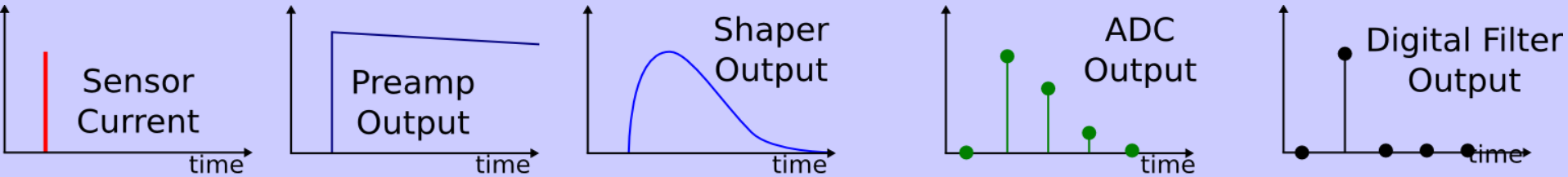
- Prototypes in 180-nm TSMC process
- Charge sensitive preamplifier
- Analog adder to provide fast feedback
- ADC : 10-bit SAR ADC
- Preparation for beam-test foreseen

Pair Monitor readout (Tohoku Univ.)

- Silicon On Insulator (SOI) technology – sensor and readout electronics are integrated in the SOI substrate. (monolithic)
- SOI 0.2 μm CMOS process, readout prototype successfully tested
noise : 260 e^- (+130 e^-/pF) expected signal : 20000 e^-



AGH-UST 0.35 μm CMOS



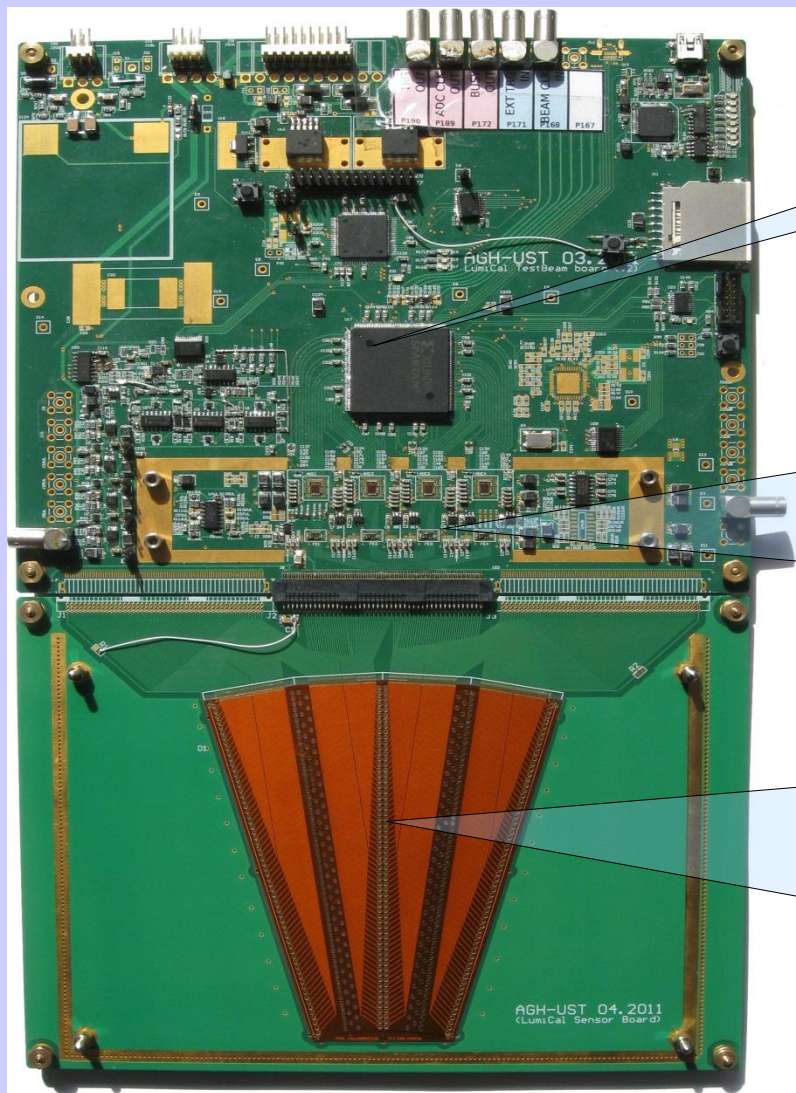
8 channel Front-End ASIC

- $T_{\text{peak}} \approx 60 \text{ ns}$
- C_{det} up to 100pF
- switched gain: $\sim 2fC < Q_{\text{in}} < 10 \text{ pC}$
- RC and FET feedback

8 channel 10-bit ADC ASIC

- 1.5 bit pipeline architecture
- 25 Ms/s (9.7 ENOB)
- Power: $\sim 1.2 \text{ mW/chan/MHz}$
- Power pulsing embedded

Module Design



Data concentrator
Xilinx Spartan 3E

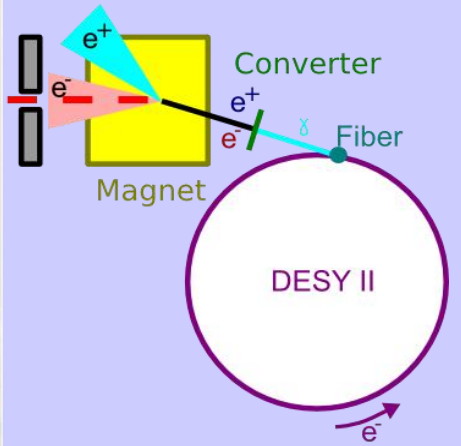
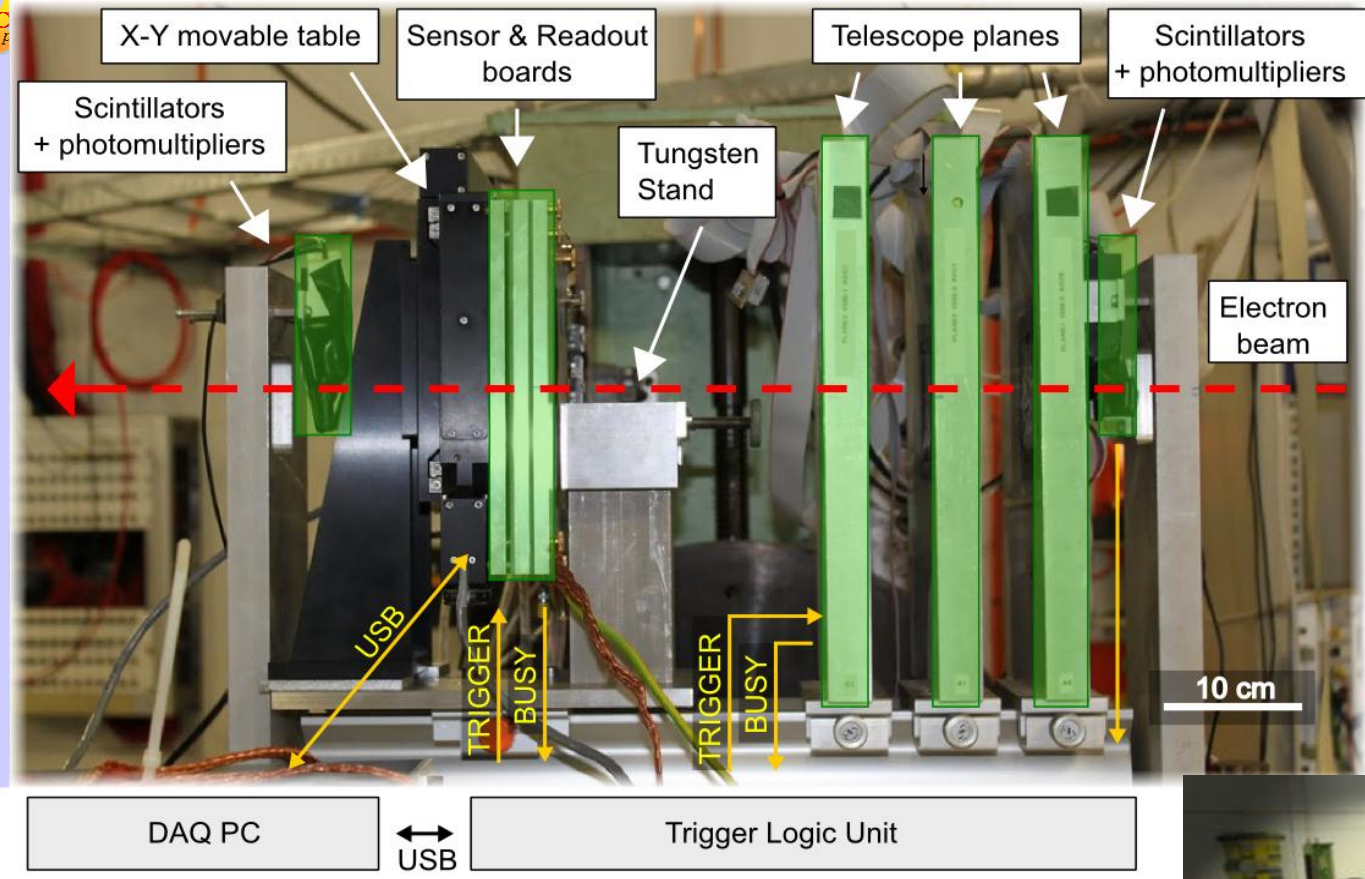
4 pairs of Front-end + ADC

A close-up view of the front-end ADCs, showing four pairs of chips labeled ADC1, ADC2, ADC3, and ADC4. Each pair is connected to a front-end chip labeled FE1, FE2, FE3, and FE4 respectively. The chips are mounted on a green PCB with various components like resistors and capacitors.

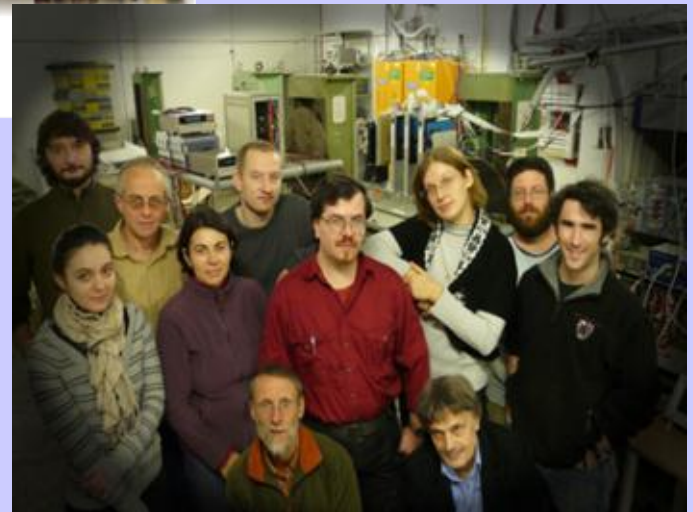
LumiCal / BeamCal sensors

Two diagrams showing the sensor arrays. The left diagram is a 3D perspective view of a fan-shaped sensor array with a grid of sensor elements. The right diagram is a 2D top-down view of the same sensor array, showing the grid pattern.

Test-beam Setup

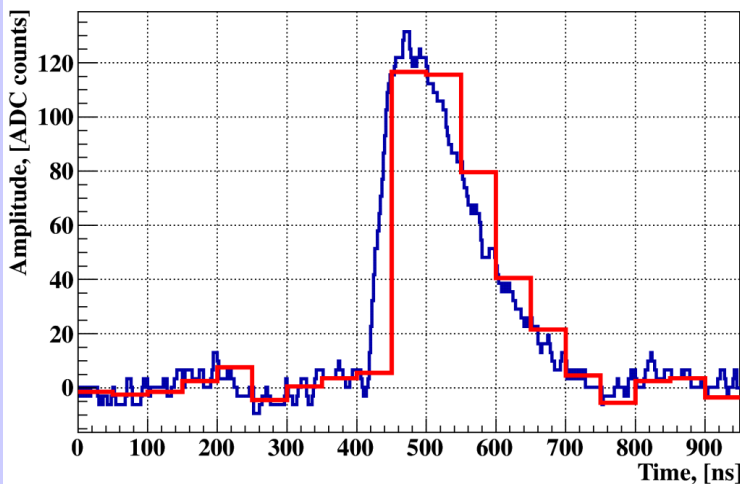


- 50x10⁶ events recorded
- different areas of the sensor
- different FE settings
- data with FE and external ADC



32 channels fully equipped (Sensor + Lumical Front-end + LumiCal ADC)

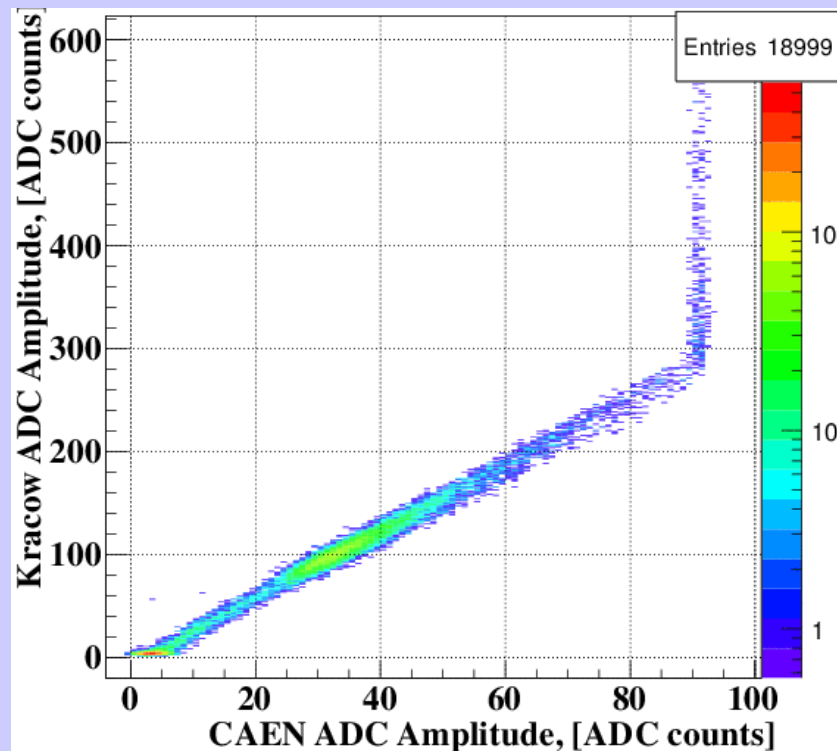
- Signal handshaking with Trigger Logic Unit (TLU)
- ADC Clock source
 - Internal (asynchronous with beam operation) – testbeam & CLIC mode
 - External (beam clock used to synchronize with beam) ILC mode
 - ADC sampling rate is up to 20 Ms/s (6.4 Gbps)



Example signal:
Signal digitized with
ADC ASIC (red) and
external ADC (blue)



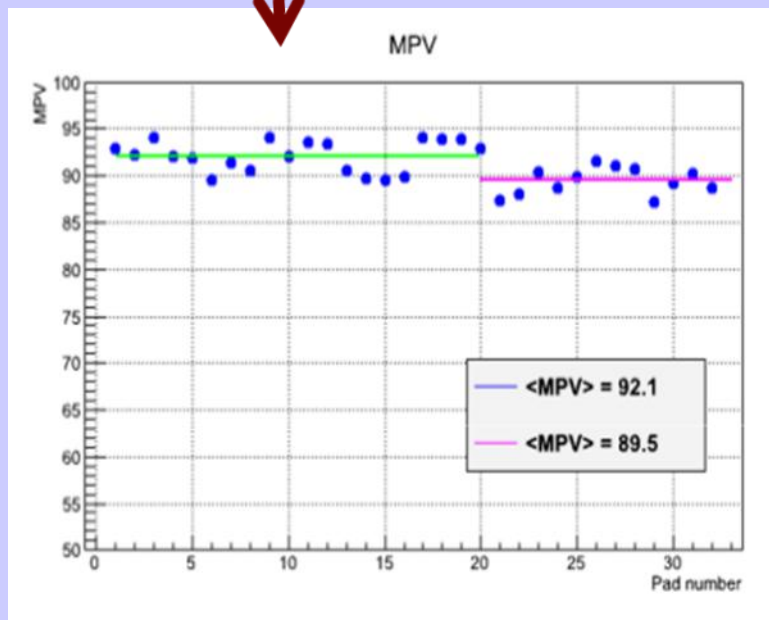
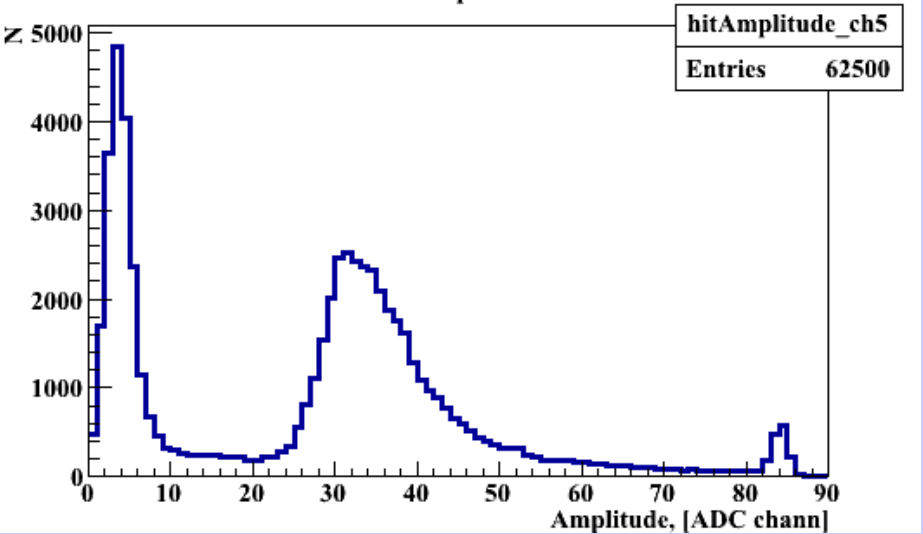
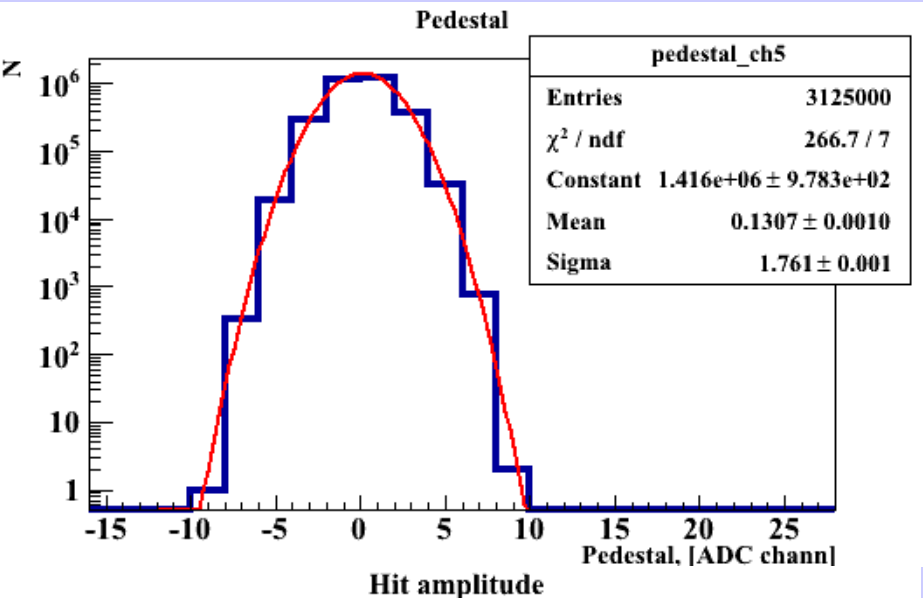
Comparison of the
amplitude measured with
the ADC ASIC and a
CAEN 500 Ms/s flash ADC

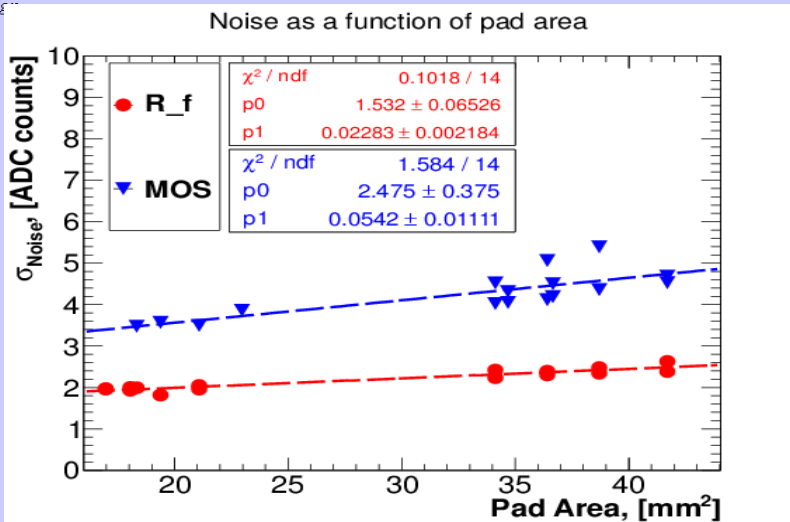


S/N ~ 22 (RC feedback & FET feedback)

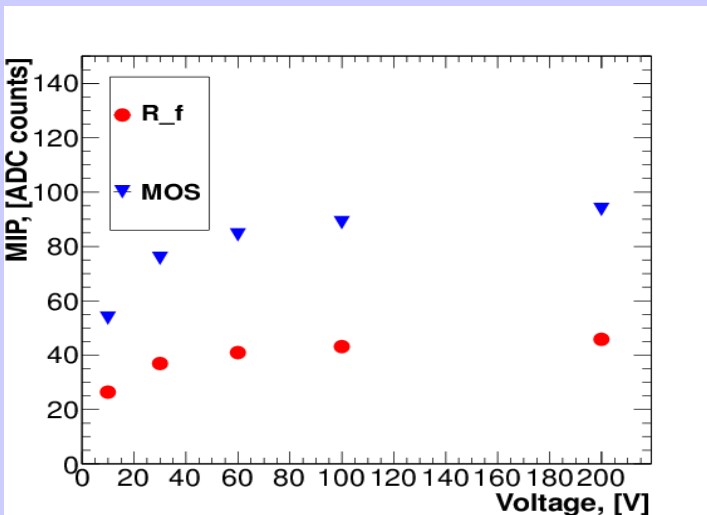


Gain vs. channel

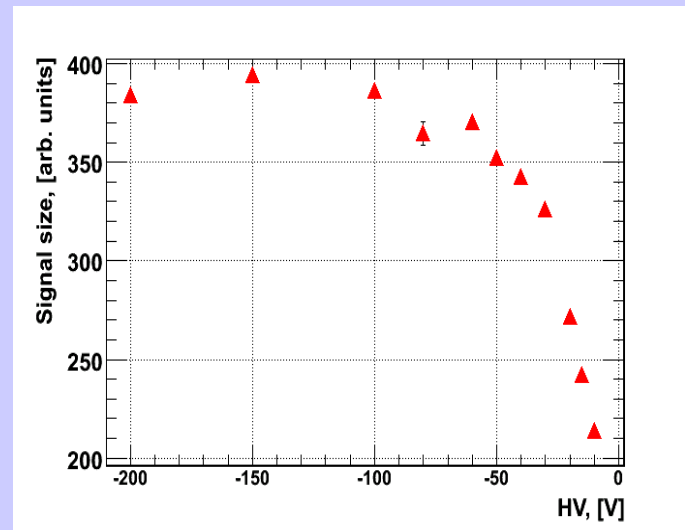




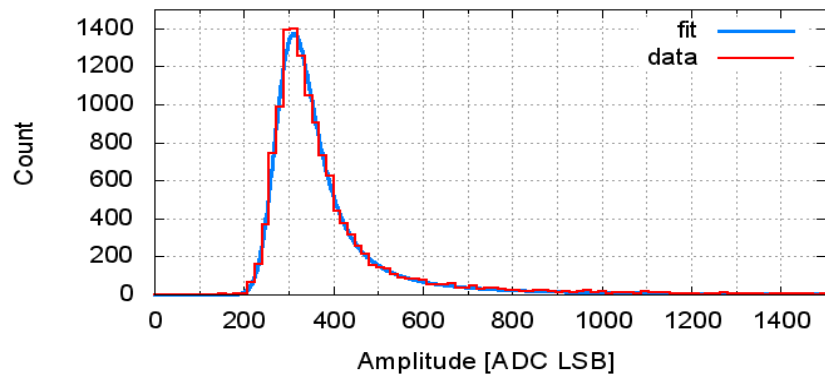
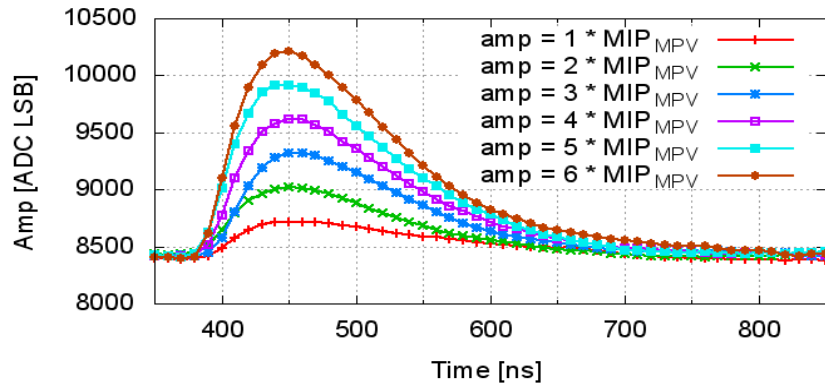
σ_{PED} as a function of the pad area



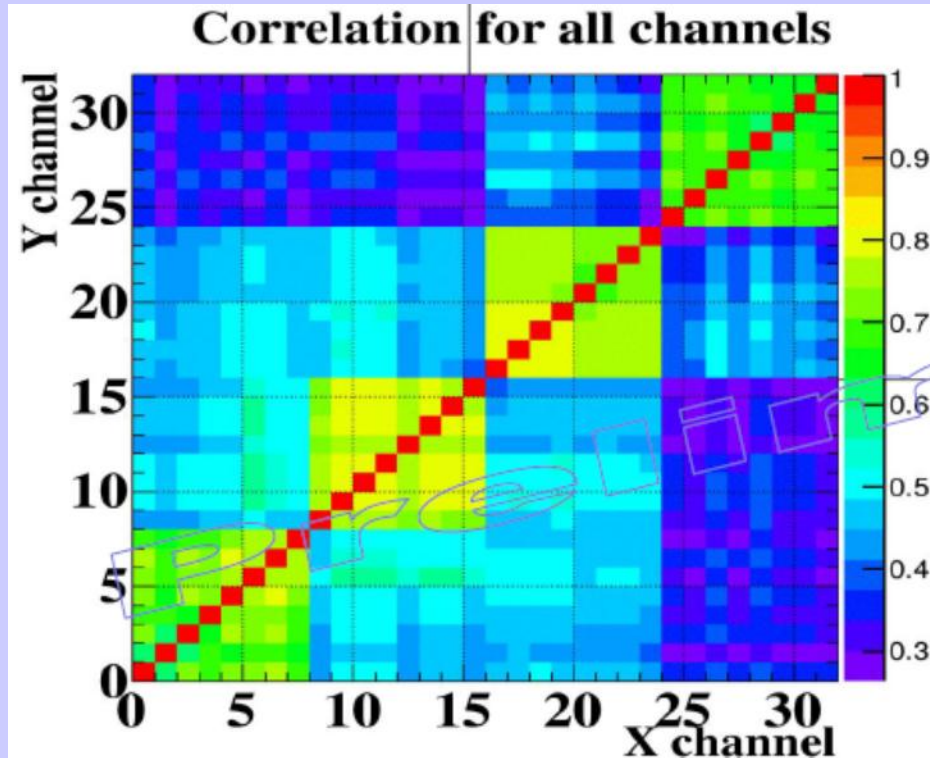
Signal as a function of the voltage, test beam (GaAs)



Signal as a function of the voltage, lab measurement



Multiparticle crossing

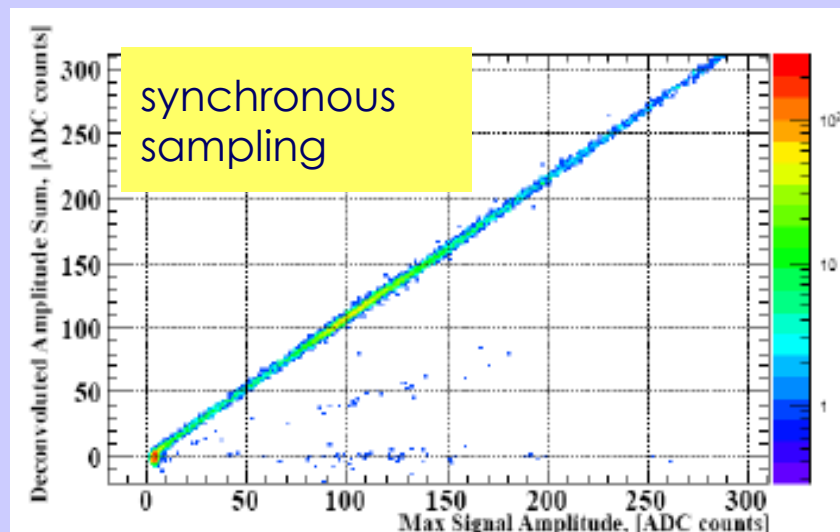
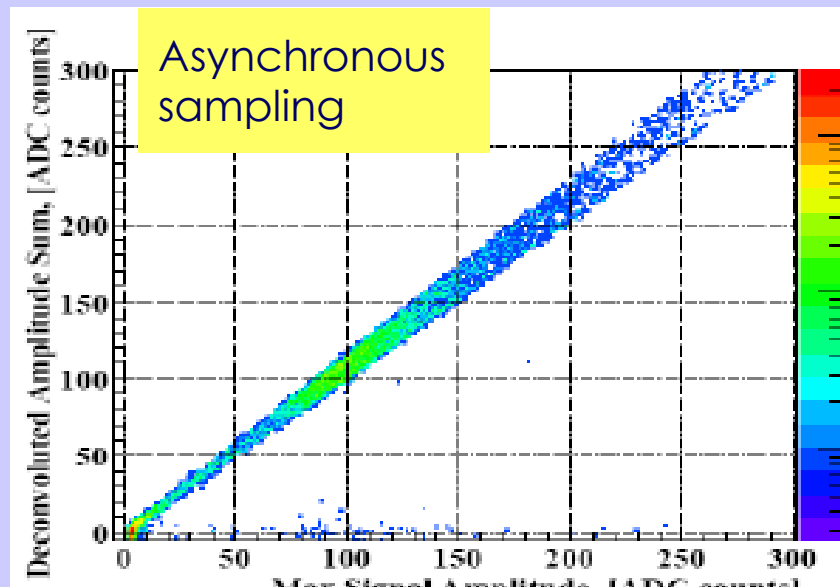
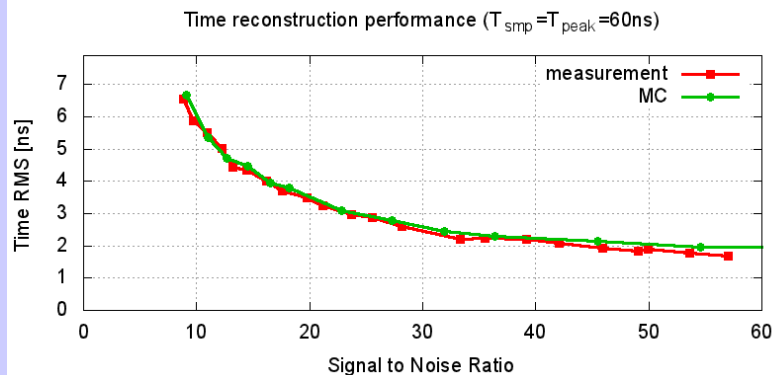
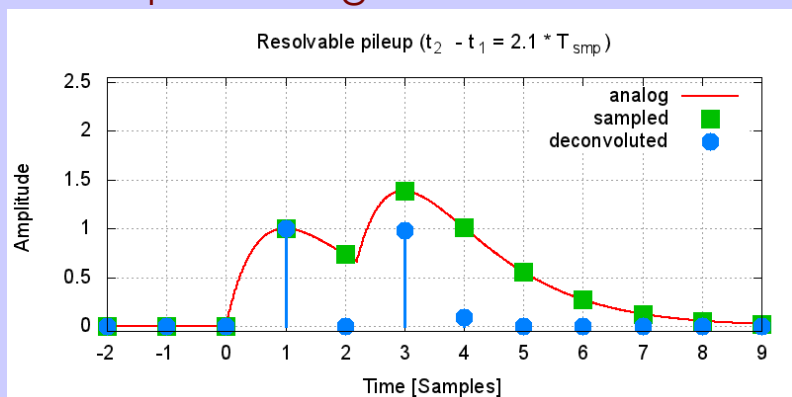


Common mode noise

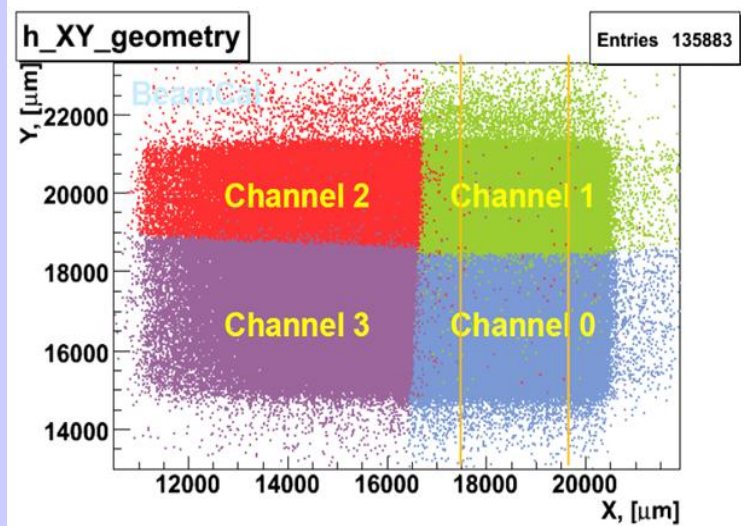
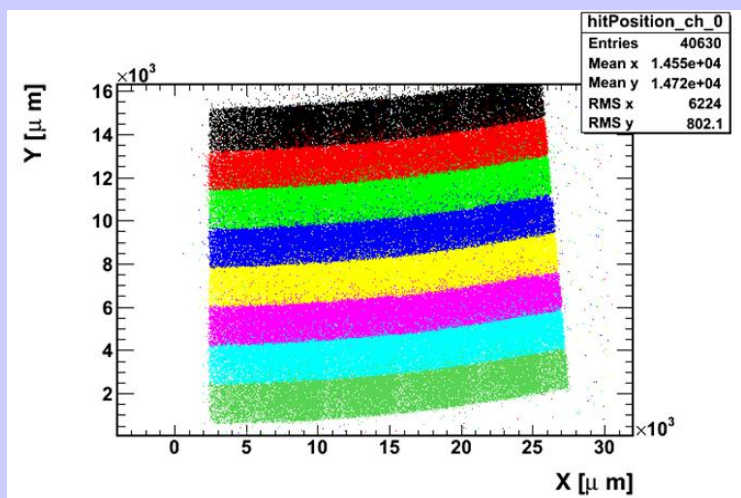


Application of signal de-convolution

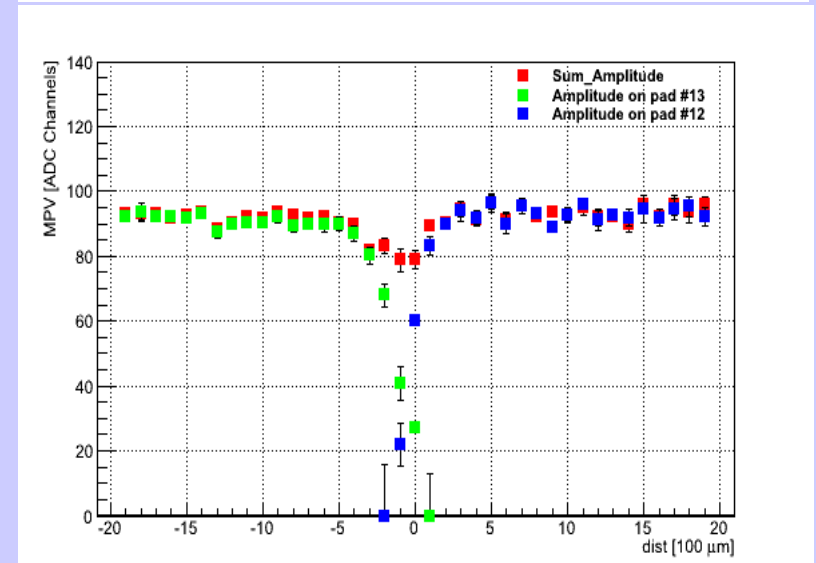
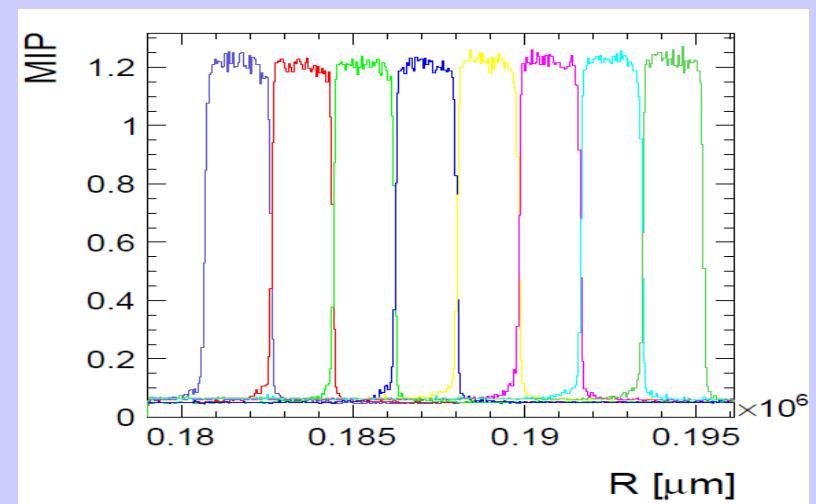
- Reduction of a long CR-RC pulse to 1 or 2 non-zero samples
- Pile-up resolving



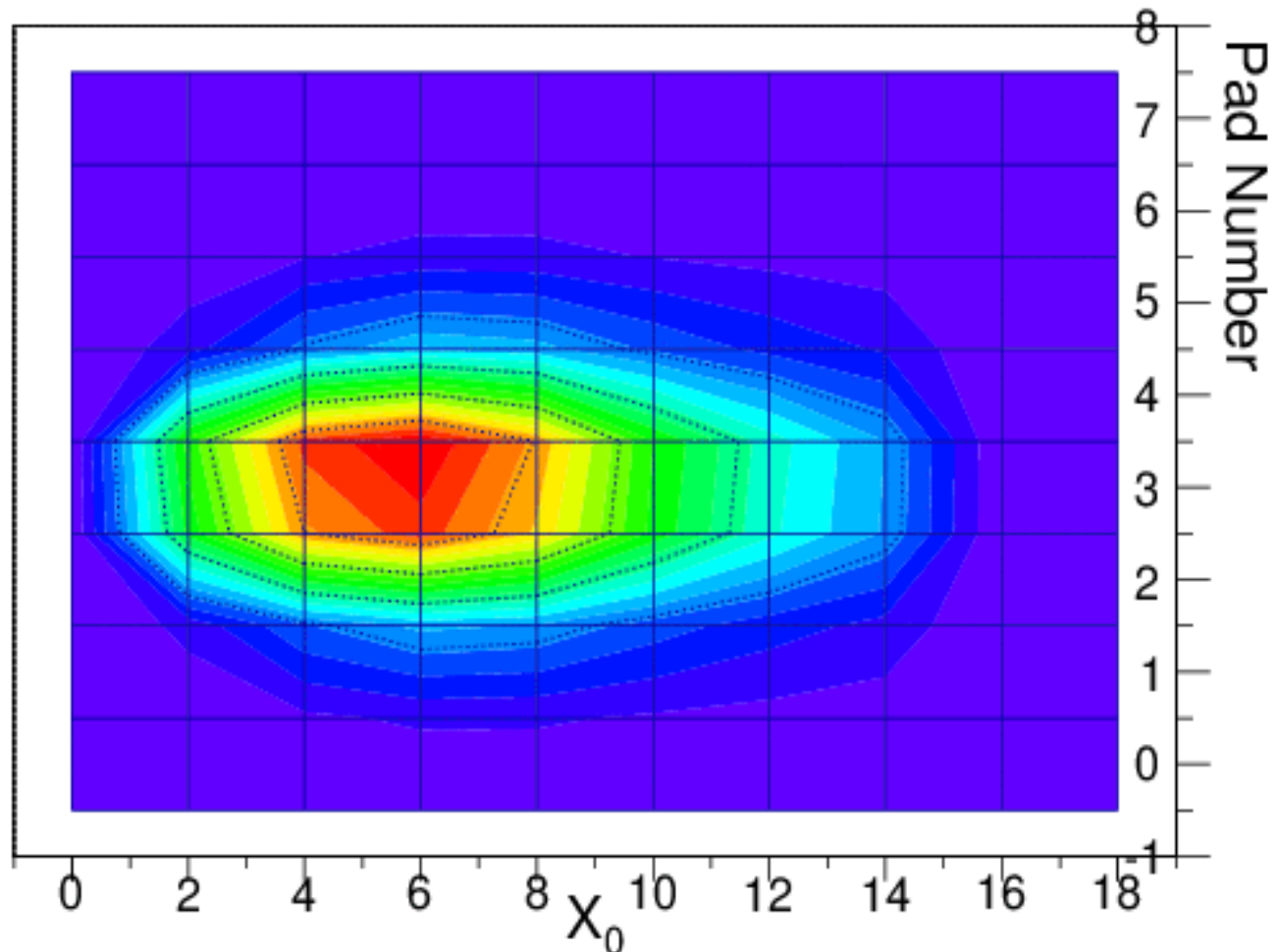
Track reconstruction using the telescope



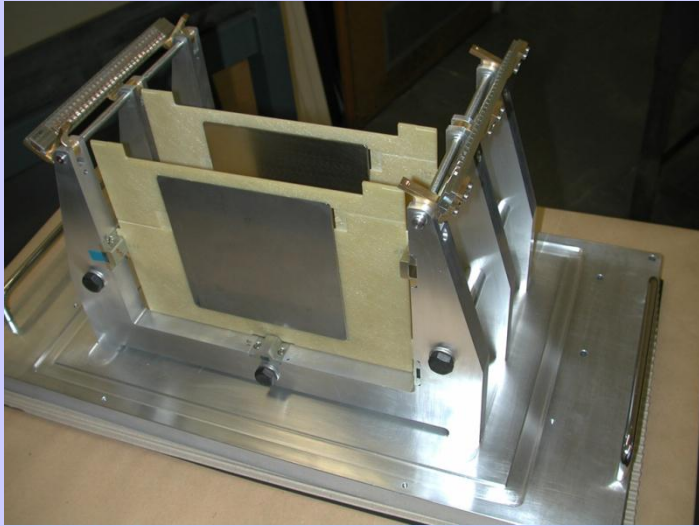
Signal amplitude on neighbour and between pads



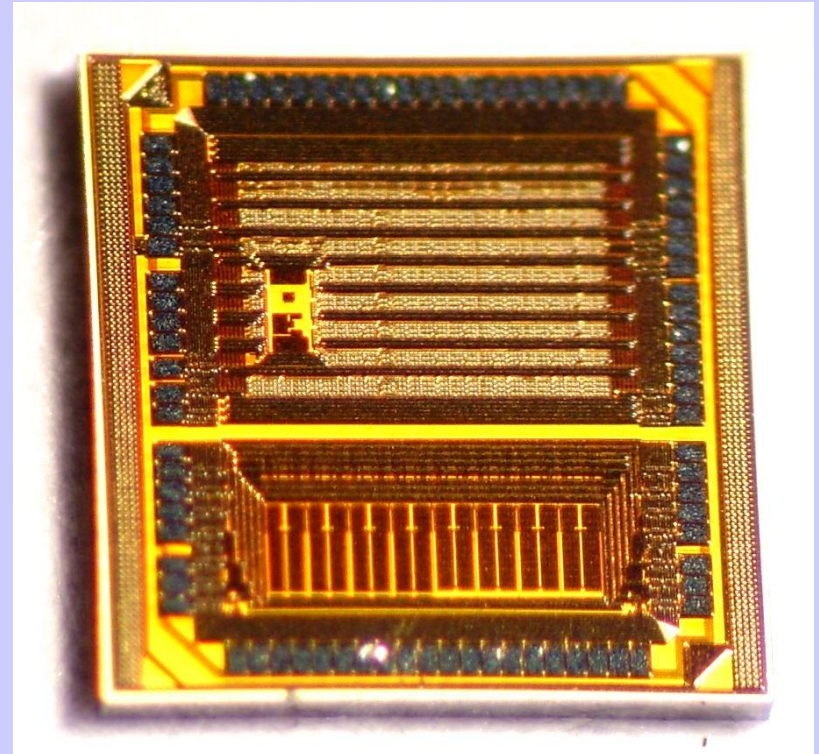
Reconstruction of the 2 D shower shape



Under development – calorimeter prototype



- 30 sensor layers and tungsten planes
- Precise positioning ($50\ \mu\text{m}$) of sensor and absorber planes, very small clearance (compact calorimeter)



ADC ASIC prototype (130 nm IBM)

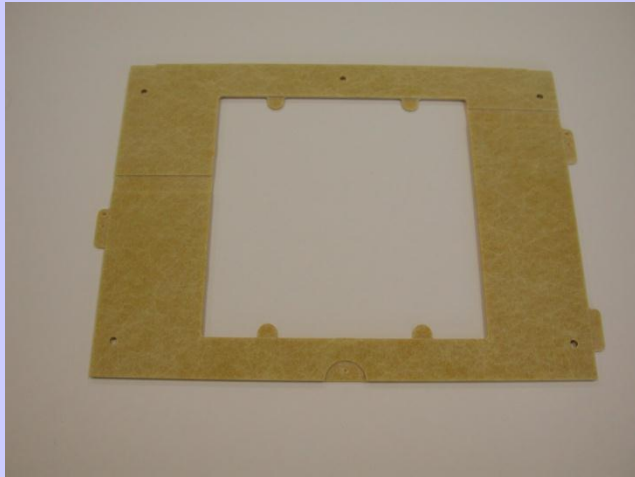
- 8 channels 10 bit SAR ADC
- Fully differential
- Sampling frequency 40 MHz

& DAQ matching AIDA standard

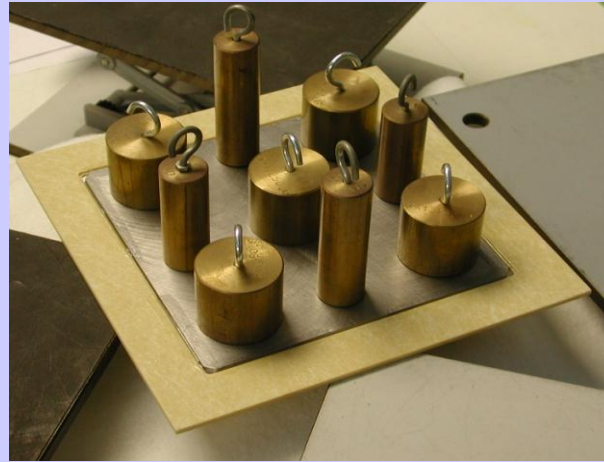
- After detailed design studies, sensors, FE and ADC ASICs are designed, tested and produced
- FE and ADC ASICs are attached to sensor prototypes (both BeamCal and LumiCal sensors) to form a fully operational sensor plane (32 channels connected)
- Performance studies are done in a test-beam
 - Stable operation with $S/N \sim 20$ (MIPs)
 - Small ($\sim 10\%$) loss of signal in the gaps
 - First estimate of a shower profile
- Ongoing work towards a prototype calorimeter with improved FE and ADC ASICs

Backup

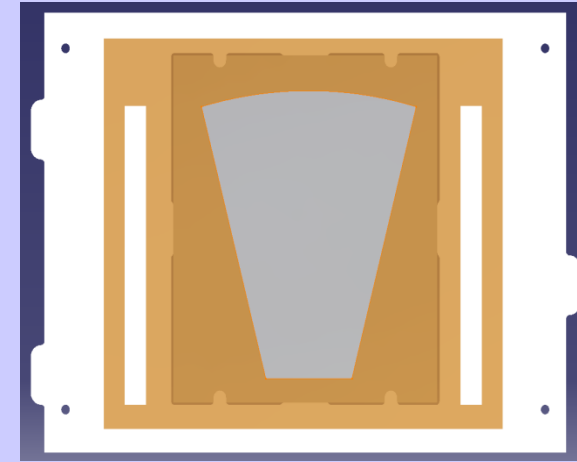
Mechanical Frame



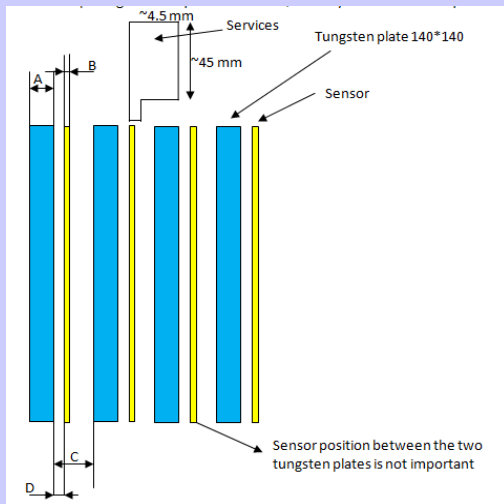
First machined permaglass frame



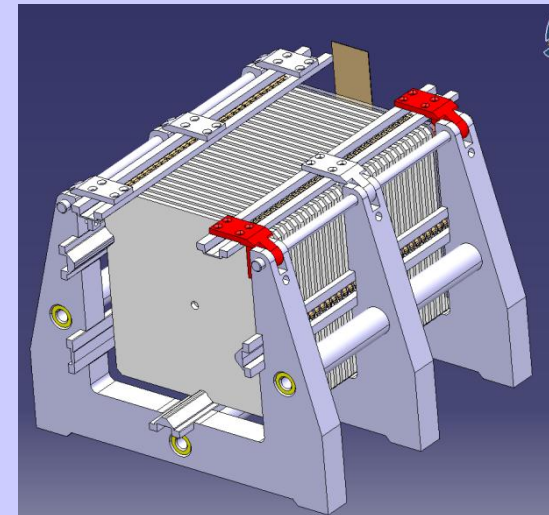
tungsten absorber plate inserted



Sensor plane



October 24, 2012

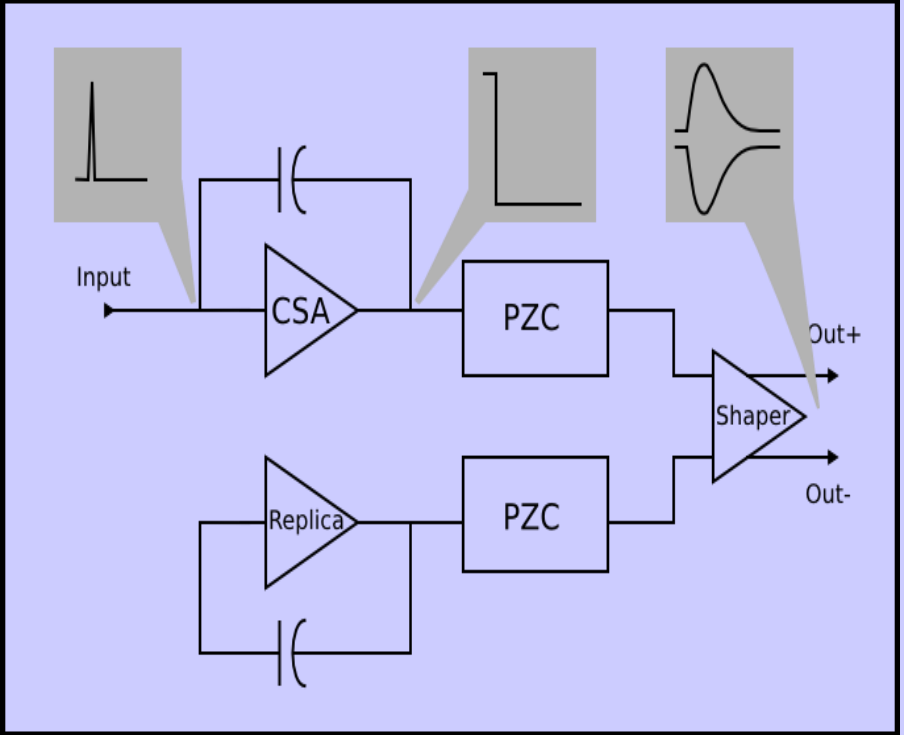


LCWS Arlington

New ASIC prototypes

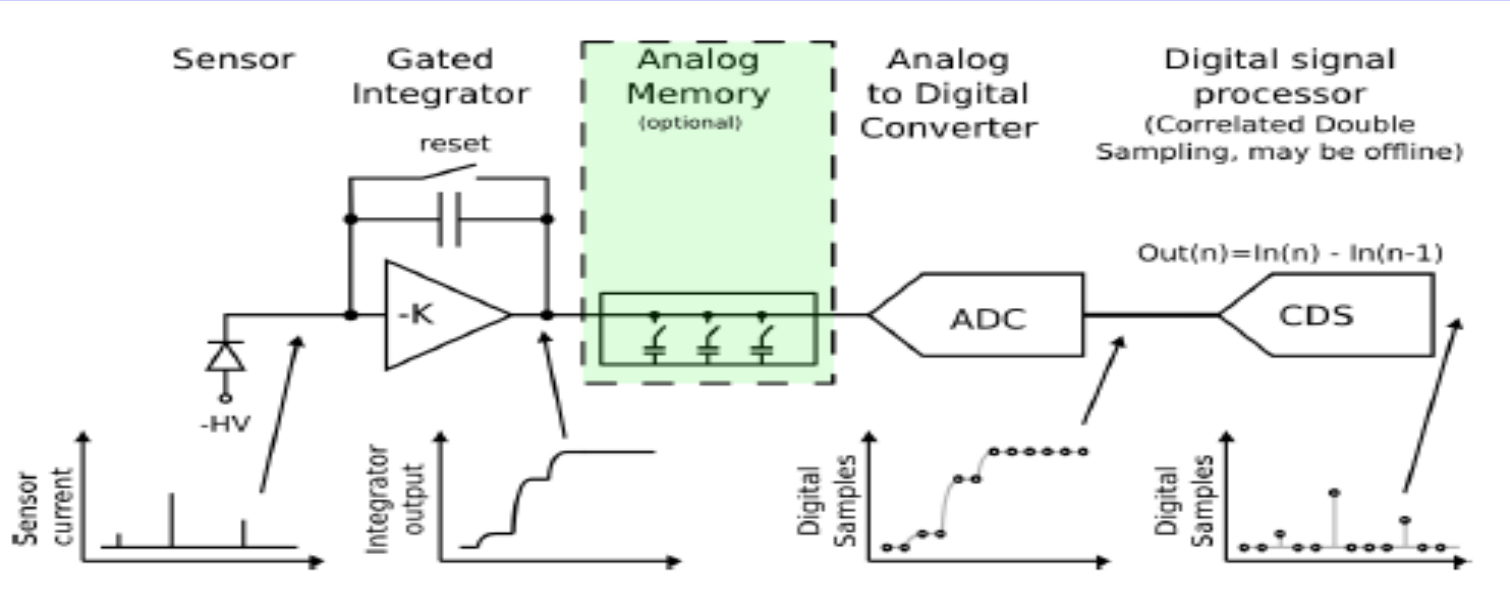
Future ASICs will be designed and produced in 130 nm IBM technology (AGH-UST Cracow)
 faster, lower power consumption, radiation hard

- 10 bit SAR ADC (submitted in February 2012)
 - 1-2 mW at 40 Ms/s
 - 150 μm pitch
- new FE ASIC, improved ADC (submission in May)
 - Charge sensitive, PZC
 - Gain 0.15mV/fC and 15 mV/fC (switchable)
 - Peaking time 25-100 ns variable
 - 2 mW/channel
- Multichannel version in 2013



CLIC Electronics (proposal)

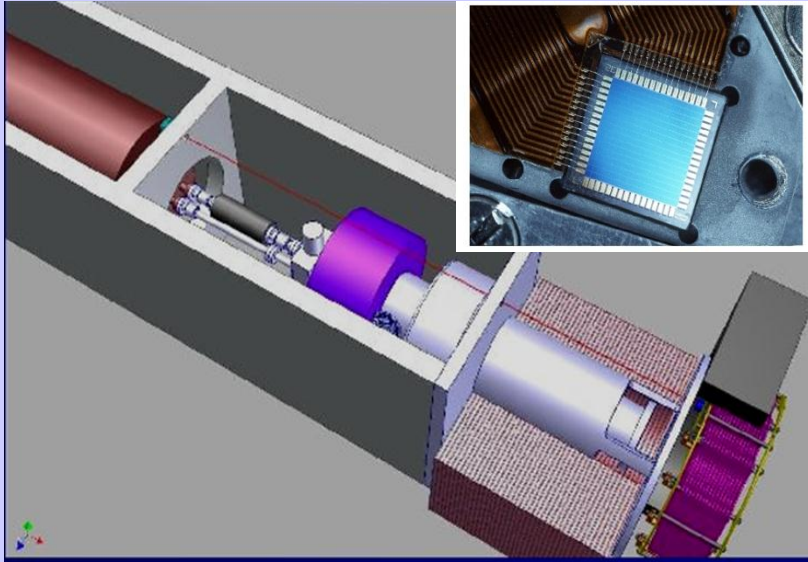
Triggerless time and amplitude reconstruction using asynchronous deconvolution or a gated integrator



With a peaking time of 60 ns and $S/N = 20$ a time resolution Of $< 2ns$ was obtained (simulation and test with dedicated hardware).

More detailed physics background simulations needed!

Alignment Concept (INPAS Cracow)



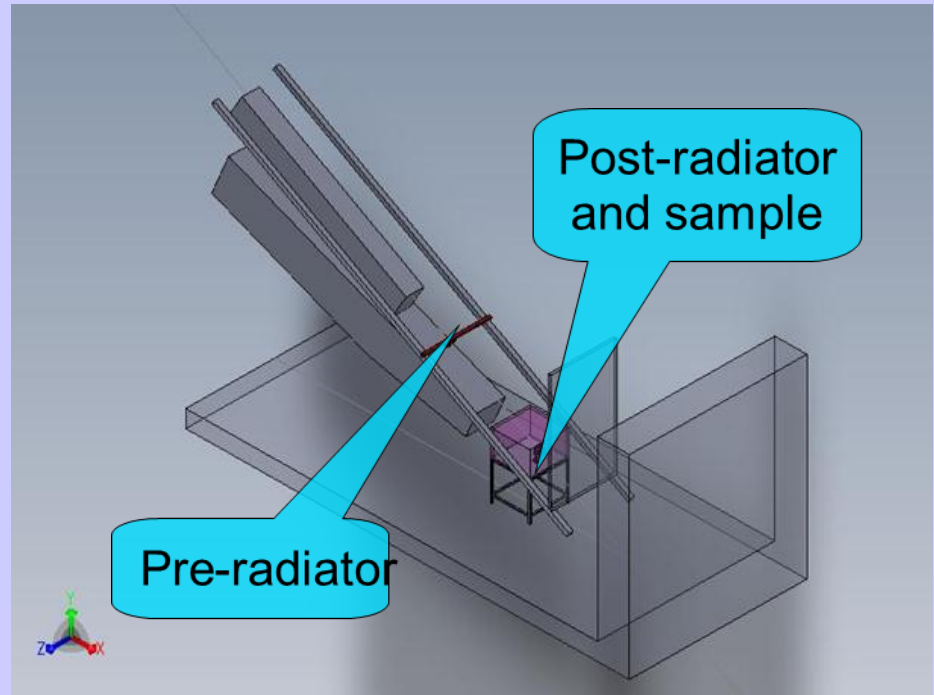
- Reference for position monitoring QD0
- Laser beams and sensors between QD0 and LumiCal
- Laser beams between both LumiCal

DAQ (INP and TAU)

- Follows the ILD standard (Calice, LCTPC)
- 4 Detector Interface units are ordered
- 1 Link Data Aggregator under test
- Concept not yet finished

Radiation Damage Study Facility (Santa Cruz)

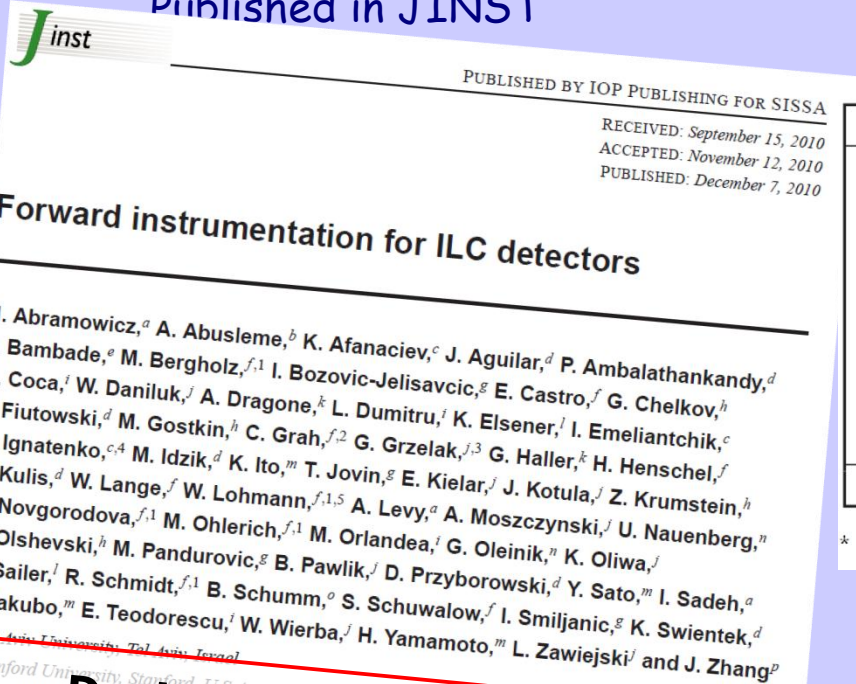
will allow performing radiation hardness studies under more realistic conditions, e.g. considering also the hadronic component in electromagnetic showers;



Design studies, background, systematic effects for 500 GeV advanced

Published in JINST

Systematics of luminosity measurement at 500GeV



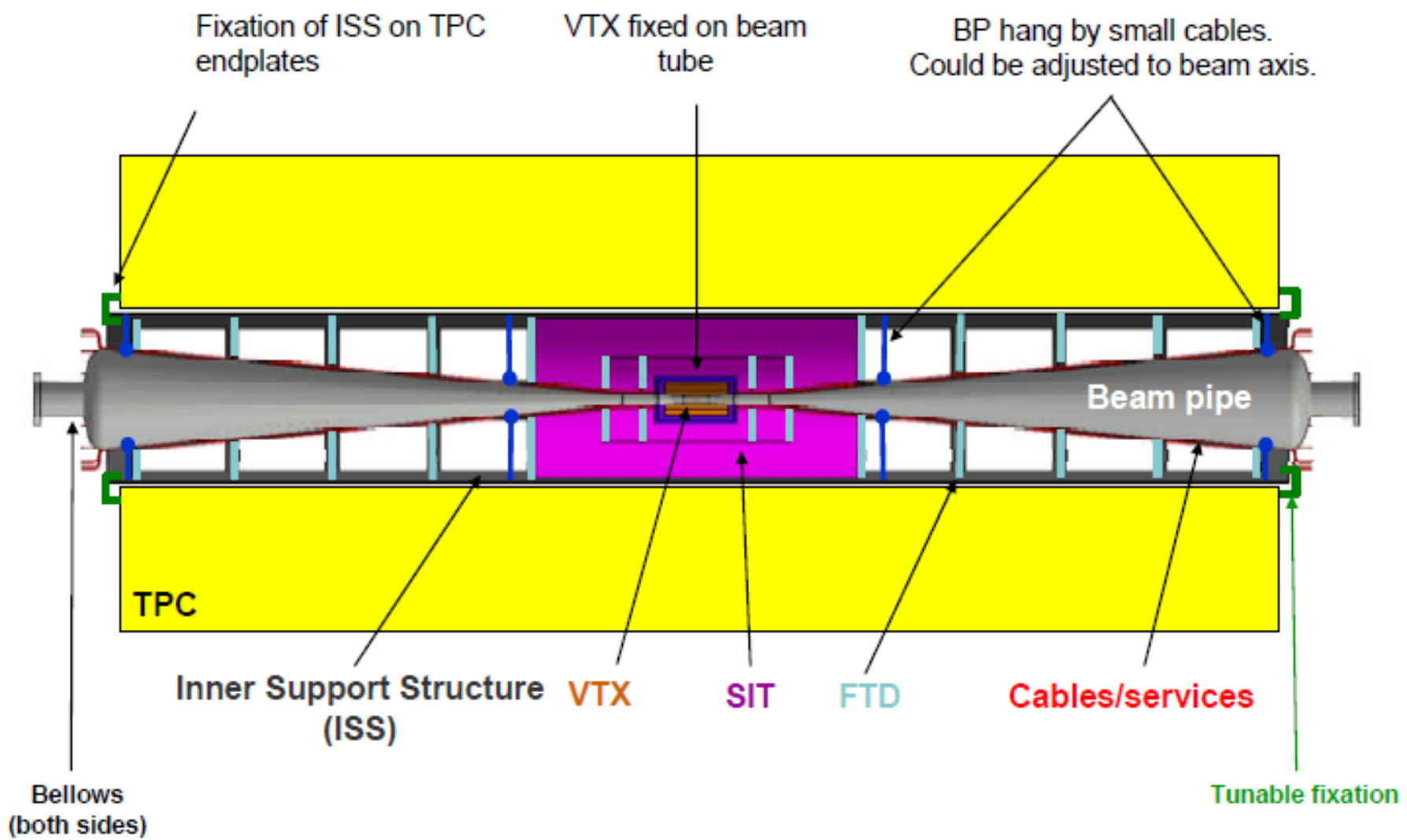
Source	Value	Uncertainty	Luminosity Uncertainty
σ_θ	2.2×10^{-2} [mrad]	100%	1.6×10^{-4}
$\Delta\theta$	3.2×10^{-3} [mrad]	100%	1.6×10^{-4}
a_{res}	0.21	15%	10^{-4}
luminosity spectrum			10^{-3}
bunch sizes σ_x, σ_z	655 nm, 300 μm	5%	1.5×10^{-3}
two photon events	2.3×10^{-3}	40%	0.9×10^{-3}
energy scale	400 MeV	100%	10^{-3}
polarisation, e^-, e^+	0.8, 0.6	0.0025	1.9×10^{-4}
total uncertainty			2.3×10^{-3}

* 100%= Upper limit – the size of effect is taken as uncertainty

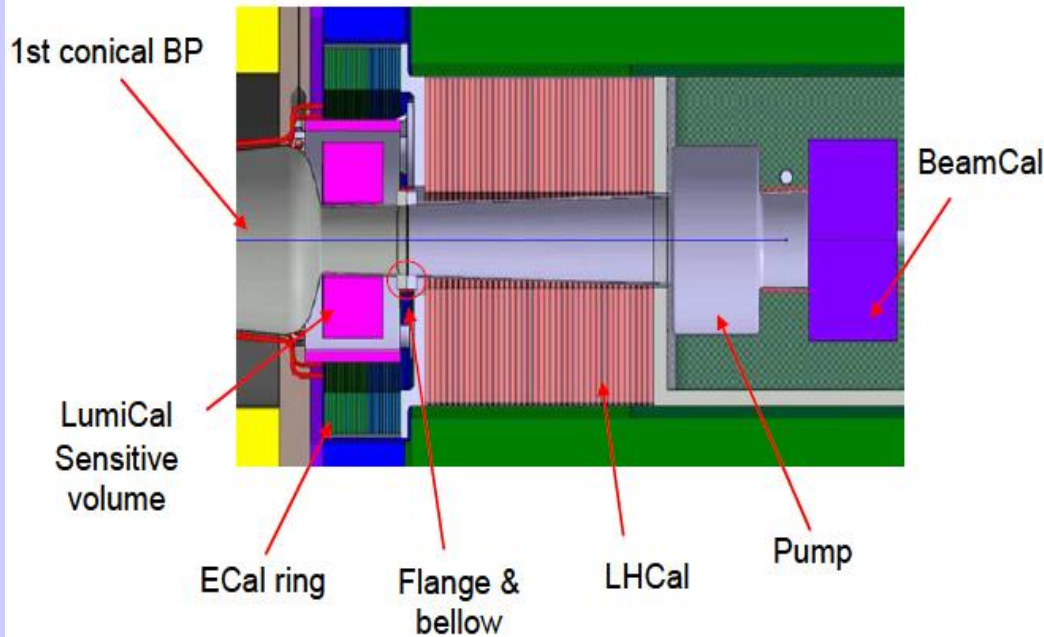
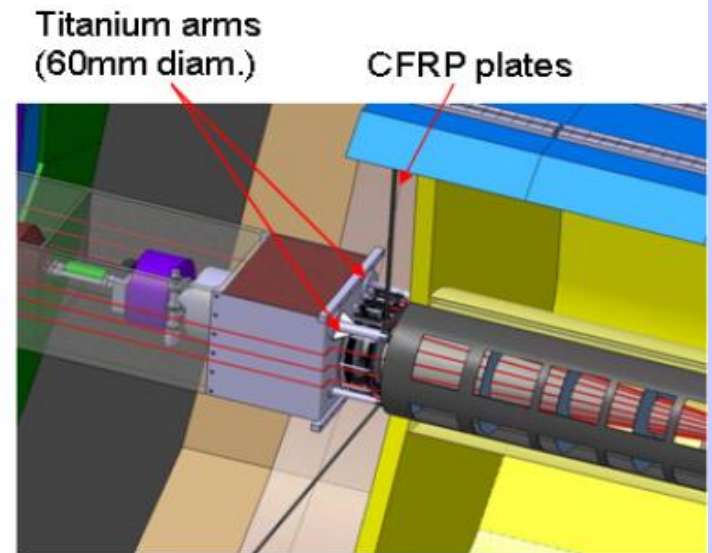
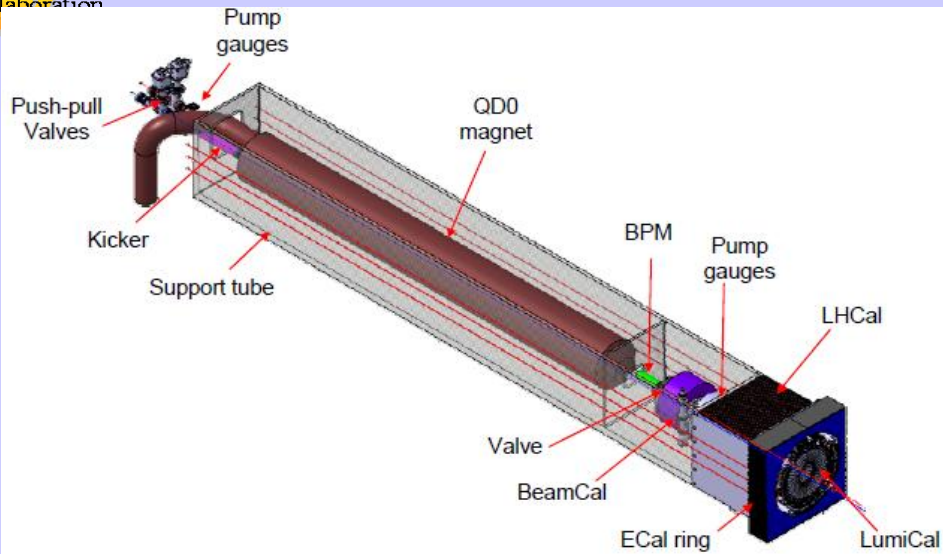
Design studies, background, systematic effects, readout electronic for 500 GeV advanced

- Cylindrical sensor-tungsten sandwich calorimeter
- Small Moliere radius
- Finely segments
- FE ASICs positioned at the outer radius

Forward Region Design, ILD

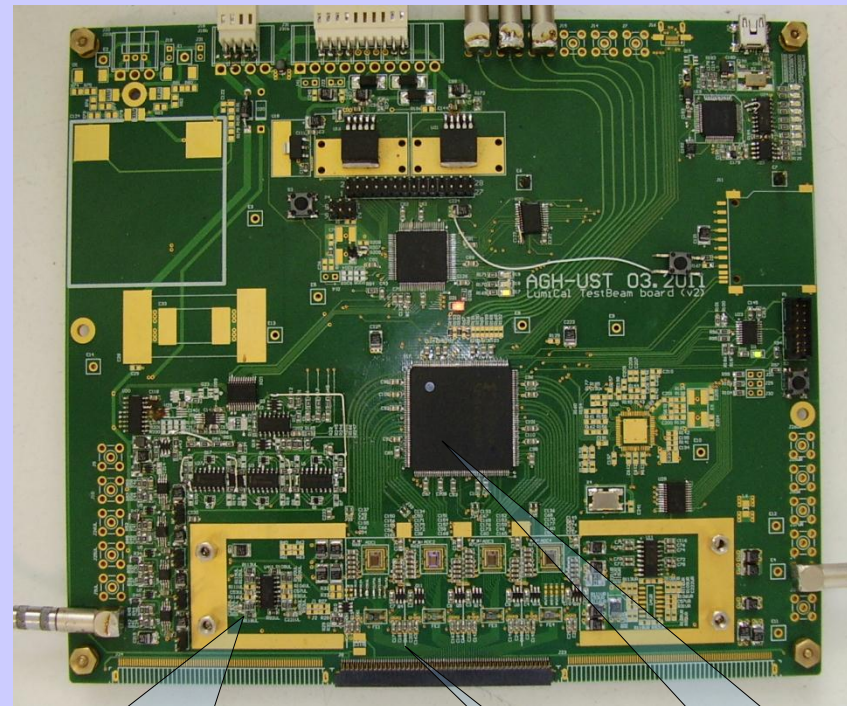


Forward Region Design, ILD



AGH-UST Cracow Readout board, 32 channels

- AMS 350 nm
- 20 Ms/s ADC
- External and self trigger
- Internal or 'beam' clock
- Data transfer via USB
- Power pulsing
- Handshaking with Trigger Logic Unit (TLU)
- Used in several beam-test ventures



4 pairs of front-end+ADC ASICs



Data concentrator
Xilinx Spartan 3E

sensor
connector